

OPTO-ELECTRONIC DEVICES DIVISION ELECTRONIC COMPONENTS GROUP SHARP CORPORATION

SPECIFICATION

DEVICE SPECIFI	
	PHOTOTRIAC COUPLER
MODEL No.	
	4SD11
	Business dealing name
	PC4SD11NXPCF
	PC4SD11YXPCF
	-
Specified for	
	•
This specification sheets and at After confirmation of the conte	the Specifications which consists of 14 pages including cover. tached sheets shall be both side copy. ents, please be sure to send back copies of the Specifications
I'his specification sheets and at After confirmation of the conte	tached sheets shall be both side copy. ents, please be sure to send back copies of the Specifications
This specification sheets and at After confirmation of the conte	tached sheets shall be both side copy. ents, please be sure to send back copies of the Specifications
This specification sheets and at After confirmation of the conte with approving signature on ea	tached sheets shall be both side copy. ents, please be sure to send back copies of the Specifications
This specification sheets and at After confirmation of the conte with approving signature on ea	tached sheets shall be both side copy. ents, please be sure to send back copies of the Specifications
This specification sheets and at After confirmation of the conte with approving signature on ea	ents, please be sure to send back copies of the Specifications ch. PRESENTED
This specification sheets and at	tached sheets shall be both side copy. ents, please be sure to send back copies of the Specifications ch.
This specification sheets and at After confirmation of the conte with approving signature on ea	tached sheets shall be both side copy. ents, please be sure to send back copies of the Specifications ch. PRESENTED DATE
This specification sheets and at After confirmation of the conte with approving signature on ea	ents, please be sure to send back copies of the Specifications ch. PRESENTED
This specification sheets and at After confirmation of the conte with approving signature on ea	tached sheets shall be both side copy. ents, please be sure to send back copies of the Specifications ch. PRESENTED DATE
This specification sheets and at After confirmation of the conte with approving signature on ea	tached sheets shall be both side copy. ents, please be sure to send back copies of the Specifications ch. PRESENTED DATE H. Imanaka,
This specification sheets and at After confirmation of the conte with approving signature on ea	ents, please be sure to send back copy. PRESENTED DATE BY

SHARP CORPORATION



Product name: PHOTOTRIAC COUPLER

Model No.: 4SD11

(Business dealing name: PC4SD11NXPCF) (Business dealing name: PC4SD11YXPCF)

- 1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please do not reproduce or cause anyone to reproduce them without Sharp's consent.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) This product is designed for use in the following application areas;
 - · OA equipment · Audio visual equipment · Home appliances
 - · Telecommunication equipment (Terminal) · Measuring equipment
 - · Tooling machines · Computers

If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.

- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as;
 - Transportation control and safety equipment (aircraft, train, automobile etc.)
 - · Traffic signals · Gas leakage sensor breakers · Rescue and security equipment
 - · Other safety equipment
- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as;
 - Space equipment · Telecommunication equipment (for trunk lines)
 - Nuclear power control equipment Medical equipment
- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.
- 3. Please contact and consult with a Sharp sales representative for any questions about this product.



1. Application

This specification applies to the outline and characteristics of phototriac coupler Model No. 4SD11 (Apply line voltage 200V AC).

2. Outline

Refer to the attached sheet, page 4.

3. Ratings and characteristics

Refer to the attached sheet, page 5, 6.

4. Reliability

Refer to the attached sheet, page 7.

5. Outgoing inspection

Refer to the attached sheet, page 8.

6. Supplement

6.1 Business dealing name

("O" mark indicates business dealing name of ordered product)

Product	Business dealing name	Remarks
	PC4SD11NXPCF	
	PC4SD11YXPCF	* Applied to products as an option (Attachment-1-1 to 1-3)

6.2 Package specification

Refer to the attached sheet, page 9,10.

- 6.3 Isolation voltage shall be measured in the following method.
 - (1) Short between pins 1 to 3 on the primary side and between pins 4 to 6 on the secondary side.
 - (2) The dielectric withstanding tester with zero-cross circuit shall be used.
 - (3) The wave form of applied voltage shall be a sine wave.

(It is recommended that the isolation voltage be measured in insulation oil.)

6.4 This Model is approved by UL and CSA.

Approved Model No.: 4SD11

UL file No. : E64380

CSA file No.: CA95323

CSA approved mark " shall be indicated on minimum unit package.

6.5 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

6.6 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFC_S, Halon, Carbon tetrachloride,

1.1.1-Trichloroethane (Methyl chloroform)

6.7 Brominated flame retardants

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this device at all.



7. Notes

7.1 Circuit design

- (1) The LED used in the Phototriac coupler generally decreases the light emission power by operation. In case of long operation time, please decide I_F value so that I_F is more than 2 times of the Maximum value of the Minimum triggering current at circuit design with considering the decreases of the light emission power of the LED. (50% / 5years)
- (2) Input current (I_F) at off state shall be set 0.1mA or less.
- (3) In case that pulse drive is carried out, the pulse width of input signal should be 1ms or more.
- 7.2 Usage

Please use only for triggering medium and high power triac.

(This model shall be used under the conditions on which power triac turns on.)

- 7.3 Cleaning
- (1) Solvent cleaning: Solvent temperature 45°C or less, Immersion for 3 min or less
- (2) Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs by cleaning bath size,

ultrasonic power output, cleaning time, PCB size or device mounting condition etc.

Please test it in actual using condition and confirm that doesn't occur any defect

before starting the ultrasonic cleaning.

(3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

When the other solvent is used, there are cases that the packaging resin is eroded.

Please use the other solvent after thorough confirmation is performed in actual using condition.

7.4 Precautions for Soldering Phototriac couplers

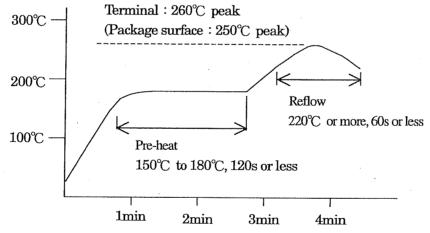
(1) In the case of flow soldering (Whole dipping is possible.)

It is recommended that flow soldering be carried out at 270°C or less and within 10s

(Pre-heating: 100 to 150°C, 30 to 80s): Within 2 time

(2) If solder reflow:

It is recommended to be carried out done at the temperature and the time within the temperature profile as shown in the figure below. (2 times or less)



(3) In the case of hand soldering

It is recommended that hand soldering be carried out at 400°C or less and within 3s :within 2 times

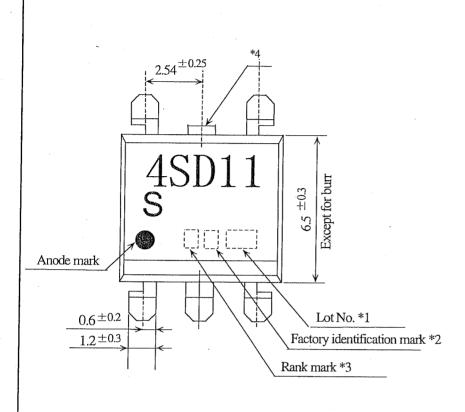
(4) Other notes

Depending on equipment and soldering conditions (temperature, Using solder etc.), the effect to investigate between PCP and lead pine of abote several principal statement.

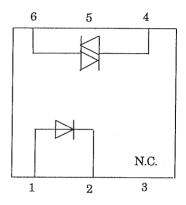
the effect to junction between PCB and lead pins of photocoupler is different.

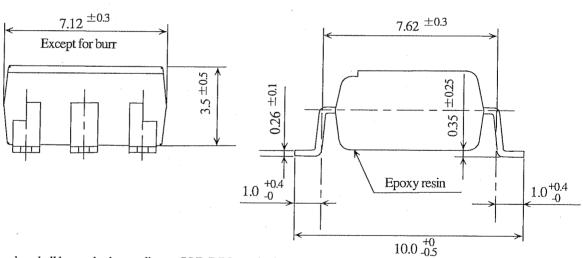
Please confirm that there is no problem on the actual use conditions.





Pin-Number and internal connection diagram





- *1) 2-digit number shall be marked according to OLD DIN standard.
- *2) Factory identification mark applies to the below.

Without: SUN-S Corporation(Japan)

: SUN-S Electronic Technology (KUNSHAN) Co. Ltd (China)

*3) Rank mark: "C"

Any external connection with Pin 5 is not allowable. Pin 5 is cut at outside of package.

Pin material: Copper Alloy

Pin finish: SnCu plating (Cu: TYP. 2%)

Unit: 1/1mm 4SD11 **Outline Dimensions** Name (Business dealing name: PC4SD11NXPCF)

Product mass : Approx.0.33g



3.1 Absolute maximum ratings

Ta=25°C

	Parameter	Symbol	Rating	Unit
Input	Forward current *1	l current *1 I _F		mA
трис	Reverse voltage	V_R	6	V
Output	RMS on-state current *1	I _T (rms)	0.1	A
	Peak one cycle surge current	Isurge	1.2 (50Hz sine wave)	A
	Repetitive peak off-state voltage	V_{DRM}	800	V
	Isolation voltage *2	Viso(rms)	5	kV
	Operating temperature	Topr	-30 to +100	$^{\circ}\!\mathbb{C}$
Storage temperature Soldering temperature		Tstg	-55 to +125	$^{\circ}\mathbb{C}$
		Tsol	270 (For 10s)	$^{\circ}\mathbb{C}$

^{*1} The derating factors of absolute maximum rating due to ambient temperature are shown in Fig.1, 2.

3.2 Electrical characteristics

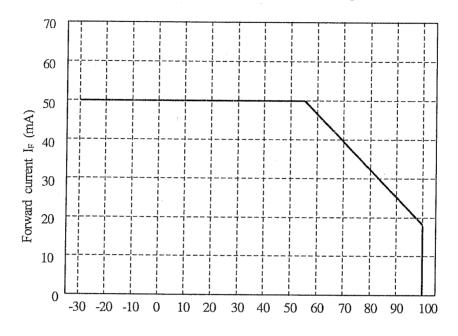
Ta=25°C

Parameter Symbol MIN. TYP. MAX. Unit							10 25 C
	Parameter		MIN.	TYP.	MAX.	Unit	Conditions
Input	Forward voltage	V_{F}	-	1.2	1.4	V	I _F =20mA
прис	Reverse current	I_R	-	-	10 ⁻⁵	A	V _R =3V
	Repetitive peak off-state current	I_{DRM}	-	-	3×10 ⁻⁶	Α	V _D =V _{DRM}
Output	On-state voltage	V_{T}	-	-	2.5	V	I _T =0.1A
Output	Holding current	I_{H}	0.1		3.5	mA	V _D =6V
	Critical rate of rise of off-state voltage	dv/dt	50	-	-	V/μs	$V_D=1/\sqrt{2} \cdot V_{DRM}$
Transfer	Minimum trigger current	I_{FT}	-	_	5	mA	$V_D = 6V, R_L = 100 \Omega$
charac- teristics	Isolation resistance	R _{ISO}	5×10^{10}	1011	-	Ω	DC500V 40 to 60%RH
	Tum on time	t _{ON}		-	100	μs	V_D =6V, R_L =100 Ω , I_F =20mA

^{*2} AC for 1min, 40 to 60%RH, f=60Hz

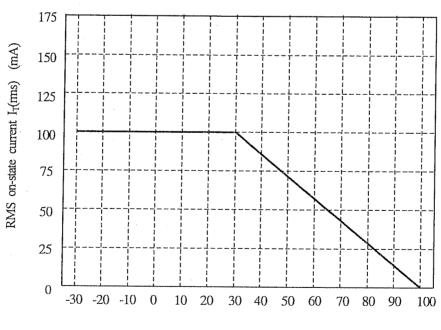


Fig.1 Forward current vs. ambient temperature



Ambient temperature Ta (°C)

Fig.2 RMS on-state current vs. ambient temperature



Ambient temperature Ta (°C)



4. Reliability

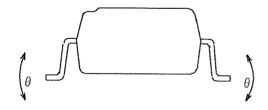
The reliability of products shall satisfy items listed below.

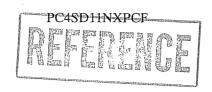
Confidence level: 90%

LTPD: 10 or 20

		LIID.	10 or 20	
Test Items	Test Conditions *1	Failure Judgement	Samples (n)	
1050 105115	Test conduction 1	Criteria	Defective(C)	
Solderability *2	245±3°C, 5s	41-141	n=11, C=0	
Soldering heat	(Flow soldering) 270°C, 10 s		n=11, C=0	
	(Soldering by hand) 400°C, 3 s		11,0-0	
Terminal strength	Weight: 5.0N		11 (0	
(Tension)	5 s/each terminal		n=11, C=0	
Terminal strength	Weight: 2.5N	$V_F>U\times 1.2$	11.00	
(Bending) *3	2 times/each terminal	***	n=11, C=0	
Mechanical shock	15km/s ² , 0.5ms	$V_T>U\times 1.2$	11 0 0	
iviechanical shock	3 times/ \pm X, \pm Y, \pm Z direction	$I_{\text{ET}}>U\times1.3$	n=11, C=0	
Variable frequency	100 to 2000 to 100Hz/4min	IFT / U / 1.5		
vibration	200m/s^2	$I_R>U\times 2.0$	n=11, C=0	
VIOILLOIT	4 times/ X, Y, Z direction	1R > 0 \ Z.0		
	1 cycle -55°C to +125°C	$I_{DRM}>U\times2.0$		
Temperature cycling	(30min) (30min)	IDRM > C / C2.0	n=22,C=0	
	20 cycles test Without Load	U: Upper specification limit		
High temp. and high	+85°C, 85%RH, 500h	LL LL LL		
humidity storage	103 C, 03 /01VII, 300/II	L: Lower specification limit	n=22,C=0	
High temp. storage	+125°C, 1000h	T	n=22,C=0	
Low temp. storage	-55°C, 1000h		n=22,C=0	
Operation life	I _F =50mA, I _T =100mA	. '		
Орстанон ше	Ta=25°C, 1000h		n=22,C=0	

- *1 Test method, conforms to EIAJ ED 4701.
- *2 Solder shall adhere at the area of 95% or more of immersed portion of lead, and pin hole or other holes shall not be concentrated on one portion.
- *3 Terminal bending direction is shown below.





5. Outgoing inspection

5.1 Inspection items

(1) Electrical characteristics $V_{F}, I_{R}, I_{DRM}, V_{T}, I_{FT}, R_{ISO}, Viso$

(2) Appearance

5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied. The AQL according to the inspection items are shown below.

Defect	Inspection item	AQL(%)
Major defect	Electrical characteristics Unreadable marking	0.065
Minor defect	Appearance defect except the above mentioned.	0.25



6.2 Package specifications

- 6.2.1 Taping conditions
 - (1) Tape structure and Dimensions (Refer to the attached sheet, Page 9)

The carrier tape has the heat pressed structure of PS material carries tape and three layers cover tape (PET material base).

- (2) Reel structure and Dimensions (Refer to the attached sheet, Page 10)
 - The taping reel shall be of plastic (PS material).
- (3) Direction of product insertion (Refer to the attached sheet, Page 10)

Product direction in carrier tape shall direct to the anode mark at the hole side on the tape.

- (4) Joint of tape
 - The cover tape and carrier tape in one reel shall be jointless.
- (5) The way to repair taped failure devices

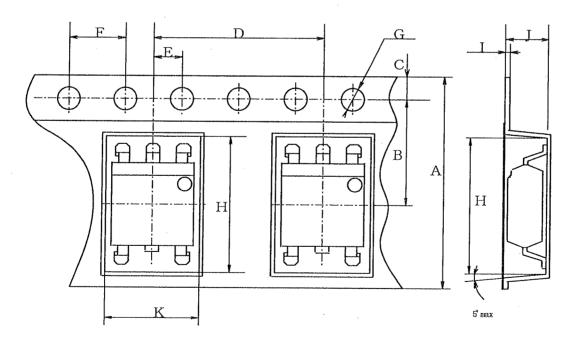
Cutting a bottom of carrier tape with a cutter, and after replacing to good devices,

the cut portion shall be sealed with adhesive tape.

- 6.2.2 Adhesiveness of cover tape
 - The exfoliation force between carrier tape and cover tape shall be 0.2N to 0.7N for the angle 160° to 180° .
- 6.2.3 Rolling method and quantity
 - Wind the tape back on the reel so that the cover tape will be outside the tape.

Attach more than 20cm of blank tape to the trailer and the leader of the tape and fix the both ends with adhesive tape. One reel shall contain 1000pcs.

- 6.2.4 Outer packing appearance (Refer to attached sheet, Page 10)
- 6.2.5 Marking
 - The outer packaging case shall be marked with following information.
 - *Model No. *(Business dealing name) *lot No. *quantity *production country *Company name *inspection date specified
- 6.2.6 Storage condition
 - Taped products shall be stored at the temperature 5 to 30°C and the humidity less than 70%RH.
- 6.2.7 Safety protection during shipping
 - There shall be no deformation of component or degradation of electrical characteristics due to shipping.

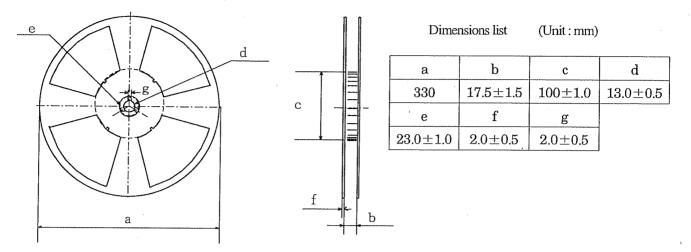


Dimensions list (Unit:mm)

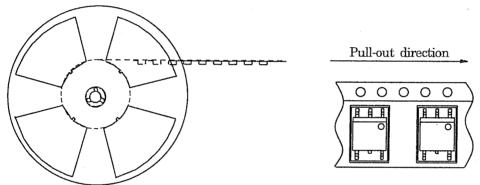
A	В	С	D	E	F	G	Н	I	J	K
16.0±0.3	7.5±0.1	1.75±0.10	12.0±0.1	2.0±0.1	4.0±0.1	+0.1 φ 1.5 -0.0	10.4±0.1	0.40±0.05	4.2±0.1	7.8±0.1



Reel structure and Dimensions

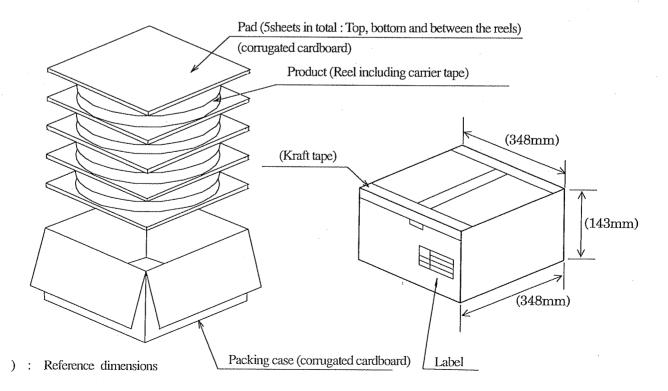


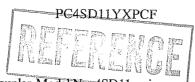
Direction of product insertion



Outer packing appearance

- (1) Carrier tape with 1,000pcs. of the devices (reeled) are packed in packing case.
- (2) The packing case is sealed by kraft tape & the label is placed on it. (Max. 4 reels are packed in one carton (Max. 4,000pcs of devices are in one carton))





1. This specification shall be applied to photocoupler, Model No. 4SD11 series as an option.

Applicable Models (Business dealing name)

PC4SD11YXPCF

3. The relevant models are the models Approved by VDE according to DIN EN 60747-5-2.

Up to date code "RD" (December 2003), the relevant models are approved by VDE according to DIN VDE 0884/08.87.

Approved Model No.: 4SD11

VDE approved No.: 40008189 (According to the specification DIN EN 60747-5-2)

· Operating isolation voltage

U_{IORM (Peak)}: 890V

Transient voltage

: 9000V

· Pollution: 2

· Clearances distance (Between input and output): 6.4 mm (MIN.)

· Creepage distance (Between input and output): 6.4 mm (MIN.)

• Isolation thickness between input and output: 0.15 mm (MIN.)

Tracking-proof: CTI 175

· Safety limit values

Current (Isi): 200mA (Diode side)

Power (Psi) : 400mW (Phototransistor side)

Temperature (Tsi): 150°C

In order to keep safety electric isolation of photocoupler, please set the protective circuit to keep within safety limit values when the actual application equipment troubled.

· Indication of VDE approval "

" is printed on the minimum packing box.

4. Outline

Refer to the attachment-1-2.

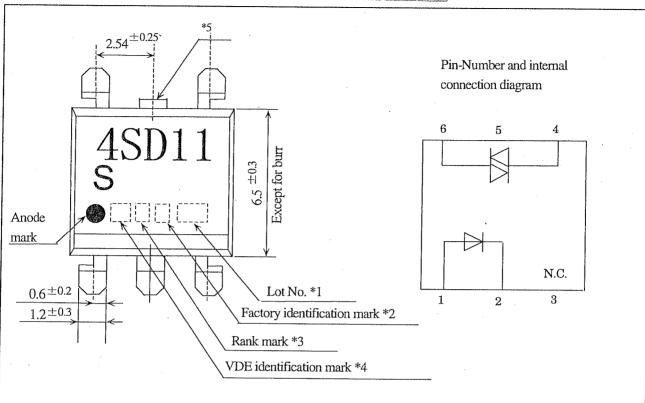
Isolation specification according to EN 60747-5-2.

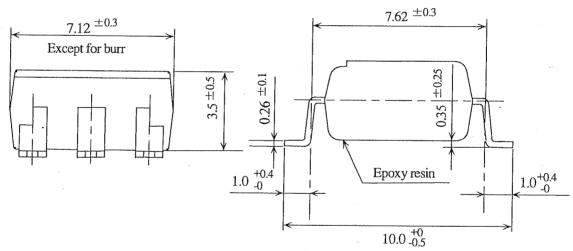
Parameter			Symbol	Conditions	Rating	Unit	Remark
Class of environmental test			-	DIN IEC68	40/100/21	-	
Pollution			-	DIN VDE0110	2	-	-
Maxin	num operatin	g isolation voltage	U _{IORM(PEAK)}	**	890	V	Refer to
Partial	discharge tes	t voltage					the Dia-
(Betwe	en input and	output)					gram 1, 2
		Diagram 1	Unr	tp=10 s, qc < 5pC	1340	V	(Attachment
		Diagram 2	Upr _(PEAK)	tp=1 s, qc < 5pC	1670	V	-1-3)
Maxim	um over-vol	tage	U _{IOTM(PEAK)}	t _{INI} =60 s	9000	V	-
Safety	maximum ra	tings					
	1) Case te	mperature	Tsi	I _F =0, Pc=0	150	$^{\circ}\!\mathbb{C}$	Refer to
	2) Input cu	ırrent	Isi	Pc=0	200	mA	Fig.1, 2
Electric power (Output or Total power dissipation)		Pși	-	400	mW	(Attachment -1-3)	
Isolation resistance				Ta=Tsi	MIN. 10 ⁹		·
(Test voltage between input and output;			R _{ISO}	Ta=Topr (MAX.)	MIN. 10 ¹¹	Ω	
	DC 500V)			Ta=25°C	MIN. 10 ¹²		

6. Precautions in performing isolation test

- 6.1 Partial discharge test methods shall be the ones according to the specifications of EN 60747-5-2
- 6.2 Please don't carry out isolation test (V_{iso}) over U_{IOTM} . This product deteriorates isolation characteristics by partial discharge due to applying high voltage (ex. U_{IOTM}). And there is possibility that partial discharge occurs in operating isolation voltage. (U_{IORM}).







- *1) 2-digit number shall be marked according to OLD DIN standard.
- *2) Factory identification mark applies to the below.

Without: SUN-S Corporation(Japan)

: SUN-S Electronic Technology (KUNSHAN) Co. Ltd (China)

- *3) Rank mark: "C"
- *4) VDE identification mark shall be marked "4".
- *5) Any external connection with Pin 5 is not allowable.

Pin 5 is cut at outside of package.

*6) Pin material: Copper Alloy

Pin finish: SnCu plating (Cu: TYP. 2%)

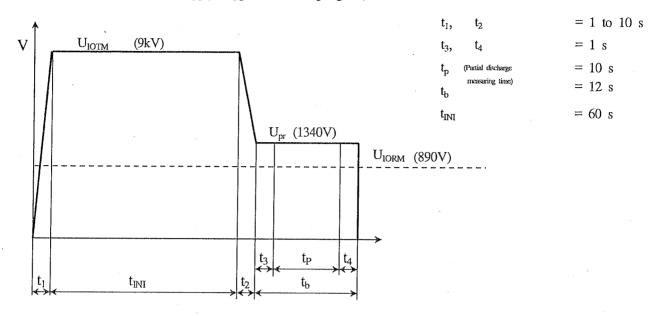
Product mass : Approx.0.33g

Name UNIT : 1/1 mm

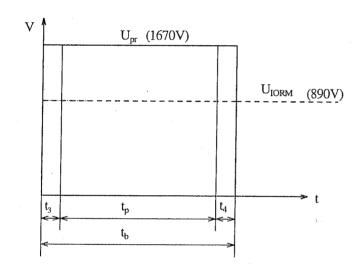
4SD11
Outline Dimensions
(Business dealing name : PC4SD11YXPCF)



Method of Diagram 1: Breakdown test (Apply to type test and sampling test)

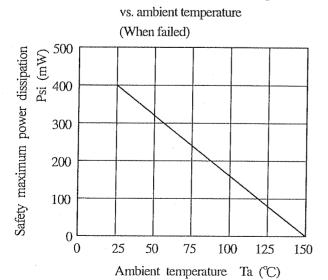


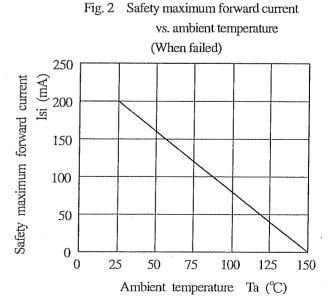
Method of Diagram 2: Non breakdown test (Apply to all device test)



Safety maximum power dissipation

 t_3 , t_4 =0.1 s t_p (Partial discharge measuring time) =1.2 s





Attachment-1-3